Attorney's Docket No.: 016820.P121

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner: Ryan, V.

Art Unit: 1641

In re Patent Application of

James Montague Cleeves

Application No. 08/581,347

Filing Date: December 29, 1995

For: WAFER TEMPERATURE CONTROL APPARATUS

AND METHOD

Assistant Commissioner for Patents Washington, D.C. 20231

AMENDMENT

Sir:

In response to the Office Action of August 4, 1998, please enter the following amendments.

IN THE SPECIFICATION

At page 2, line 26, replace "substrate" with --wafer--; and at line 27, delete "body".

At page 3, line 3, replace "substrate" with --wafer--.

At page 6, line 9, after "substrate 204" (first occurrence) insert - (e.g., having a

thickness of approximately 25-125 microns)

At page 7, line 10, replace "223" with --222--.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231 on